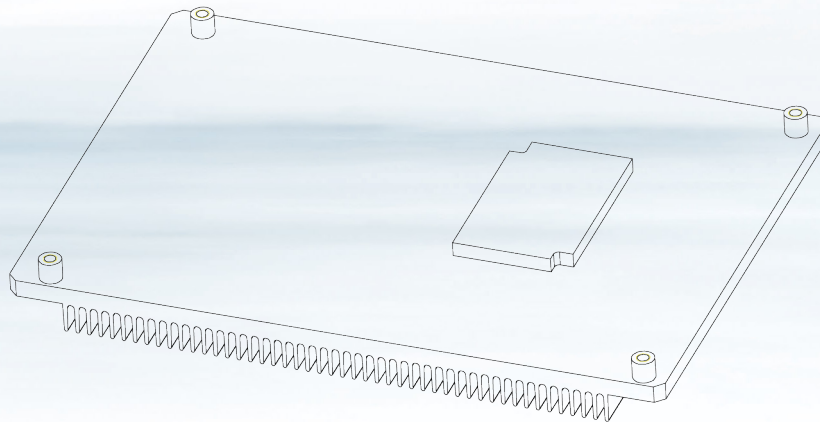


HEATSINK KIT

1067-5537



Heatsink Kit for 3.5"-SBC-APL N-Series Single Board Computer

- ▶ Aluminum heatsink
- ▶ Screw-in type mounting
- ▶ Max. 6 W TDP

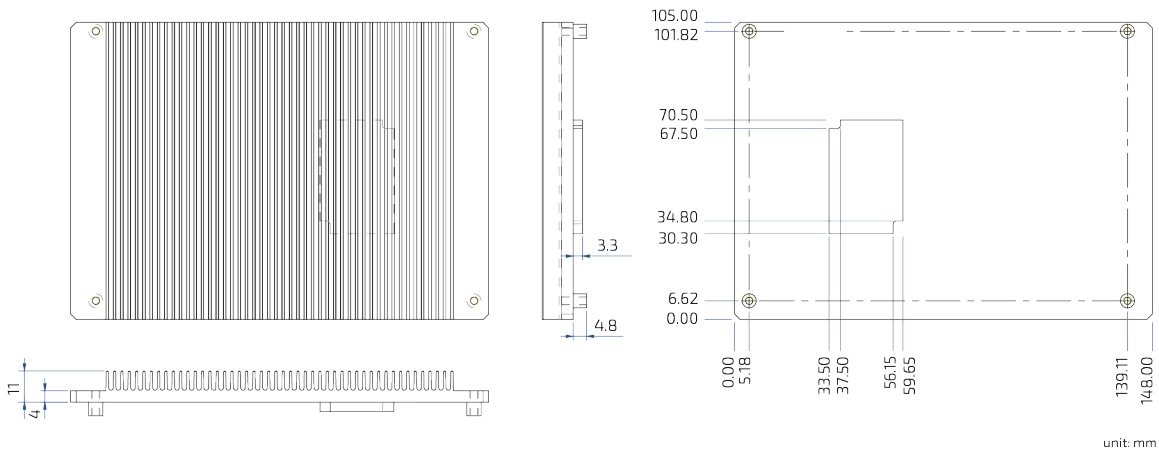
POSSIBILITIES START HERE

► TECHNICAL INFORMATION

MECHANICAL CHARACTERISTICS	SINK DIMENSION (W X D X H)	148.0 mm x 105.0 mm x 15.8 mm (5.83" x 4.13" x 0.62")
APPLICATION	SUPPORTED MAINBOARDS MAXIMUM CPU TDP SUPPORT	3.5"-SBC-APL V2.0 N-Series 6 W*

*It depends on the overall system design and airflow pattern inside the case

► MECHANICAL DIMENSIONS



► ORDERING INFORMATION

ARTICLE	PART NO.	DESCRIPTION
HEATSINK KIT	1067-5537	Heatsink with Thermal Pad, 4x M3x5 screw for 3.5"-SBC-APL w/ 6 W TDP N-Series CPU

► GLOBAL HEADQUARTERS

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